

# IRF4905STRPBF-VB Datasheet

## P-Channel 60-V (D-S) 175 °C MOSFET

### PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ )    | $I_D$ (A) <sup>d</sup> |
|--------------|------------------------------|------------------------|
| - 60         | 0.0065 at $V_{GS} = - 10$ V  | - 110                  |
|              | 0.0085 at $V_{GS} = - 4.5$ V |                        |

### FEATURES

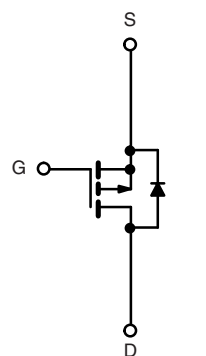
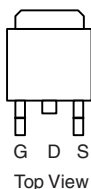
- Trench Power MOSFET
- Package with Low Thermal Resistance
- 100 %  $R_g$  Tested



Available

**RoHS\***  
 COMPLIANT

TO-263



P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_C = 25\text{ }^\circ\text{C}$ , unless otherwise noted

| Parameter                                                                      | Symbol         | Limit                                                   | Unit             |
|--------------------------------------------------------------------------------|----------------|---------------------------------------------------------|------------------|
| Drain-Source Voltage                                                           | $V_{DS}$       | - 60                                                    | V                |
| Gate-Source Voltage                                                            | $V_{GS}$       | $\pm 20$                                                |                  |
| Continuous Drain Current <sup>d</sup><br>( $T_J = 175\text{ }^\circ\text{C}$ ) | $I_D$          | $T_C = 25\text{ }^\circ\text{C}$<br>- 110               | A                |
|                                                                                |                | $T_C = 125\text{ }^\circ\text{C}$<br>- 75               |                  |
| Pulsed Drain Current                                                           | $I_{DM}$       | - 200                                                   |                  |
| Avalanche Current                                                              | $I_{AS}$       | - 85                                                    |                  |
| Single Pulse Avalanche Energy <sup>d</sup>                                     | $E_{AS}$       | 211                                                     | mJ               |
| Maximum Power Dissipation                                                      | $P_D$          | $T_C = 25\text{ }^\circ\text{C}$<br>272 <sup>c</sup>    | W                |
|                                                                                |                | $T_A = 25\text{ }^\circ\text{C}^b$<br>3.75 <sup>b</sup> |                  |
| Operating Junction and Storage Temperature Range                               | $T_J, T_{stg}$ | - 55 to 175                                             | $^\circ\text{C}$ |

### THERMAL RESISTANCE RATINGS

| Parameter           | Symbol     | Limit | Unit                      |
|---------------------|------------|-------|---------------------------|
| Junction-to-Ambient | $R_{thJA}$ | 40    | $^\circ\text{C}/\text{W}$ |
| Junction-to-Case    | $R_{thJC}$ | 0.55  |                           |

Notes:

- Duty cycle  $\leq 1\%$ .
- When Mounted on 1" square PCB (FR-4 material).
- See SOA curve for voltage derating.
- Limited by Package.

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

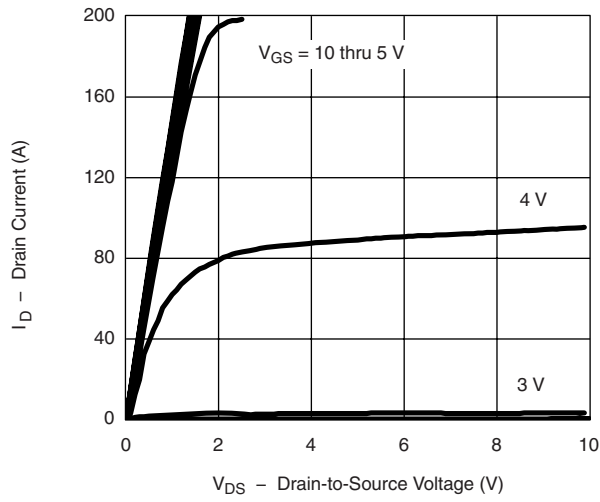
| SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted                     |               |                                                                                                                                          |       |        |           |               |
|------------------------------------------------------------------------------------------------|---------------|------------------------------------------------------------------------------------------------------------------------------------------|-------|--------|-----------|---------------|
| Parameter                                                                                      | Symbol        | Test Conditions                                                                                                                          | Min.  | Typ.   | Max.      | Unit          |
| Static                                                                                         |               |                                                                                                                                          |       |        |           |               |
| Drain-Source Breakdown Voltage                                                                 | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}$ , $I_D = -250\text{ }\mu\text{A}$                                                                                  | - 60  |        |           | V             |
| Gate-Threshold Voltage                                                                         | $V_{GS(th)}$  | $V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$                                                                                      | - 1   |        | - 3       |               |
| Gate-Body Leakage                                                                              | $I_{GSS}$     | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$                                                                                       |       |        | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current                                                                | $I_{DSS}$     | $V_{DS} = -60\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                          |       |        | - 1       | $\mu\text{A}$ |
|                                                                                                |               | $V_{DS} = -60\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                    |       |        | - 50      |               |
|                                                                                                |               | $V_{DS} = -60\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 175\text{ }^{\circ}\text{C}$                                                    |       |        | - 250     |               |
| On-State Drain Current <sup>a</sup>                                                            | $I_{D(on)}$   | $V_{DS} = -5\text{ V}$ , $V_{GS} = -10\text{ V}$                                                                                         | - 120 |        |           | A             |
| Drain-Source On-State Resistance <sup>a</sup>                                                  | $R_{DS(on)}$  | $V_{GS} = -10\text{ V}$ , $I_D = -30\text{ A}$                                                                                           |       | 0.0065 |           | $\Omega$      |
|                                                                                                |               | $V_{GS} = -10\text{ V}$ , $I_D = -30\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                     |       | 0.0129 |           |               |
|                                                                                                |               | $V_{GS} = -10\text{ V}$ , $I_D = -30\text{ A}$ , $T_J = 175\text{ }^{\circ}\text{C}$                                                     |       | 0.016  |           |               |
|                                                                                                |               | $V_{GS} = -4.5\text{ V}$ , $I_D = -20\text{ A}$                                                                                          |       | 0.0085 |           |               |
| Forward Transconductance <sup>a</sup>                                                          | $g_{fs}$      | $V_{DS} = -15\text{ V}$ , $I_D = -50\text{ A}$                                                                                           | 20    |        |           | S             |
| Dynamic <sup>b</sup>                                                                           |               |                                                                                                                                          |       |        |           |               |
| Input Capacitance                                                                              | $C_{iss}$     | $V_{GS} = 0\text{ V}$ , $V_{DS} = -25\text{ V}$ , $f = 1\text{ MHz}$                                                                     |       | 9200   |           | pF            |
| Output Capacitance                                                                             | $C_{oss}$     |                                                                                                                                          |       | 975    |           |               |
| Reverse Transfer Capacitance                                                                   | $C_{rss}$     |                                                                                                                                          |       | 760    |           |               |
| Total Gate Charge <sup>c</sup>                                                                 | $Q_g$         | $V_{DS} = -30\text{ V}$ , $V_{GS} = -10\text{ V}$ , $I_D = -110\text{ A}$                                                                |       | 160    | 240       | nC            |
| Gate-Source Charge <sup>c</sup>                                                                | $Q_{gs}$      |                                                                                                                                          |       | 40     |           |               |
| Gate-Drain Charge <sup>c</sup>                                                                 | $Q_{gd}$      |                                                                                                                                          |       | 36     |           |               |
| Gate Resistance                                                                                | $R_g$         | $f = 1\text{ MHz}$                                                                                                                       | 1.5   | 3      | 4.5       | $\Omega$      |
| Turn-On Delay Time <sup>c</sup>                                                                | $t_{d(on)}$   | $V_{DD} = -30\text{ V}$ , $R_L = 0.27\text{ }\Omega$<br>$I_D \cong -110\text{ A}$ , $V_{GEN} = -10\text{ V}$ , $R_G = 2.5\text{ }\Omega$ |       | 20     | 30        | ns            |
| Rise Time <sup>c</sup>                                                                         | $t_r$         |                                                                                                                                          |       | 190    | 285       |               |
| Turn-Off Delay Time <sup>c</sup>                                                               | $t_{d(off)}$  |                                                                                                                                          |       | 140    | 210       |               |
| Fall Time <sup>c</sup>                                                                         | $t_f$         |                                                                                                                                          |       | 300    | 450       |               |
| Source-Drain Diode Ratings and Characteristics $T_C = 25\text{ }^{\circ}\text{C}$ <sup>b</sup> |               |                                                                                                                                          |       |        |           |               |
| Continuous Current                                                                             | $I_S$         |                                                                                                                                          |       |        | - 110     | A             |
| Pulsed Current                                                                                 | $I_{SM}$      |                                                                                                                                          |       |        | - 200     |               |
| Forward Voltage <sup>a</sup>                                                                   | $V_{SD}$      | $I_F = -50\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                                             |       | - 1.0  | - 1.5     | V             |
| Reverse Recovery Time                                                                          | $t_{rr}$      | $I_F = -50\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$                                                                                |       | 60     | 90        | ns            |
| Peak Reverse Recovery Charge                                                                   | $I_{RM(REC)}$ |                                                                                                                                          |       | - 3    | - 4.5     | A             |
| Reverse Recovery Charge                                                                        | $Q_{rr}$      |                                                                                                                                          |       | 0.09   | 0.2       | $\mu\text{C}$ |

Notes:

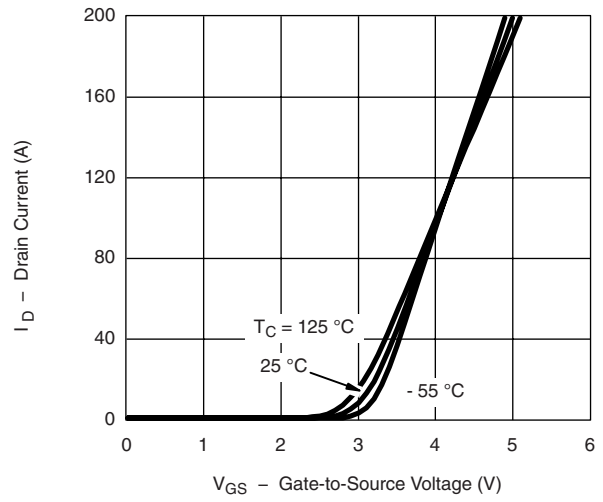
- Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

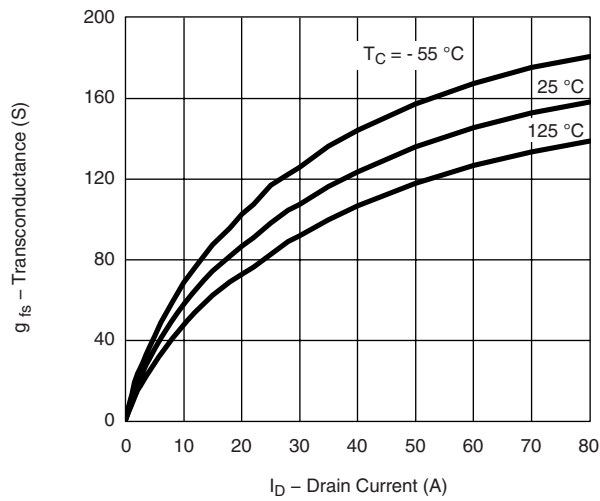
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



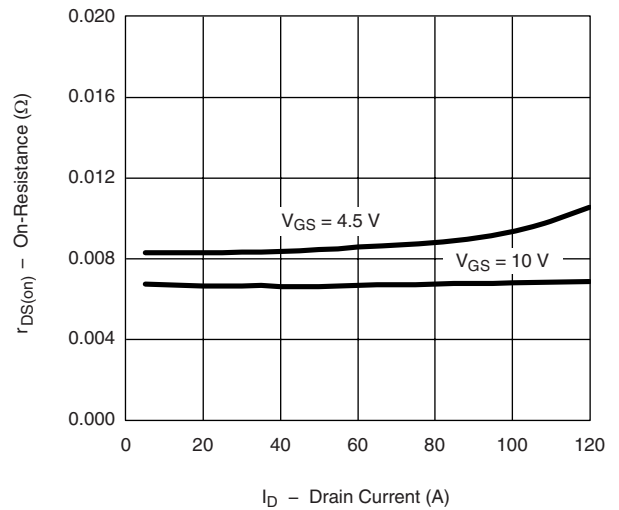
**Output Characteristics**



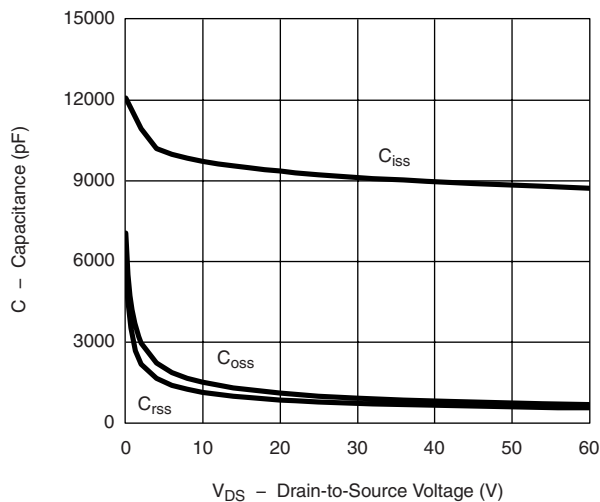
**Transfer Characteristics**



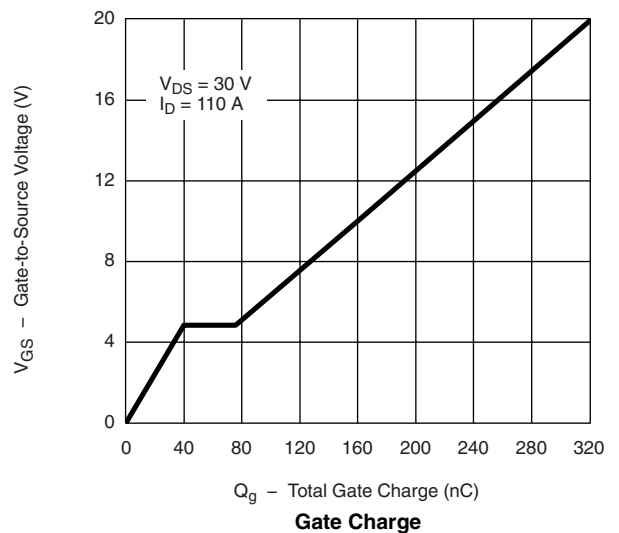
**Transconductance**



**On-Resistance vs. Drain Current**

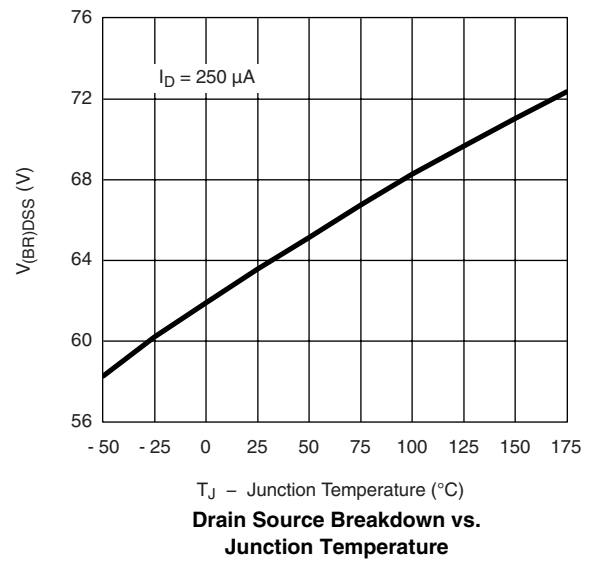
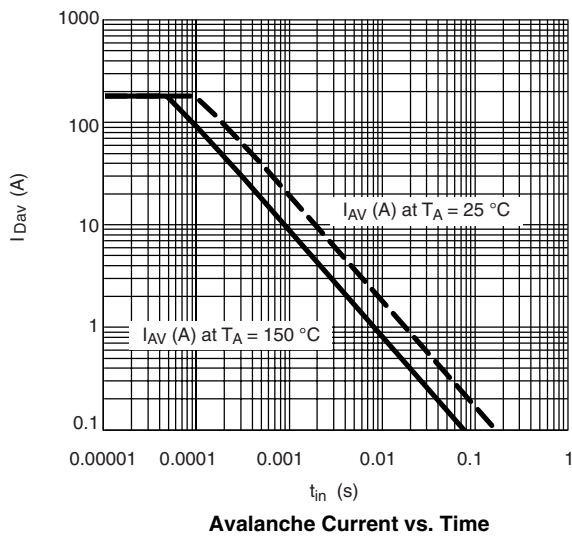
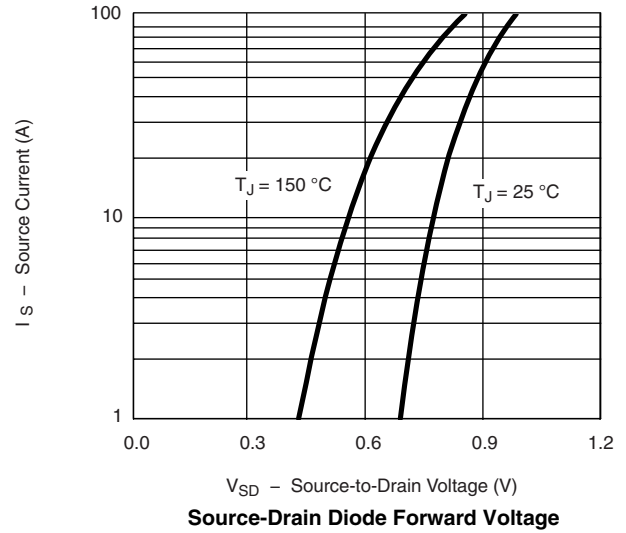
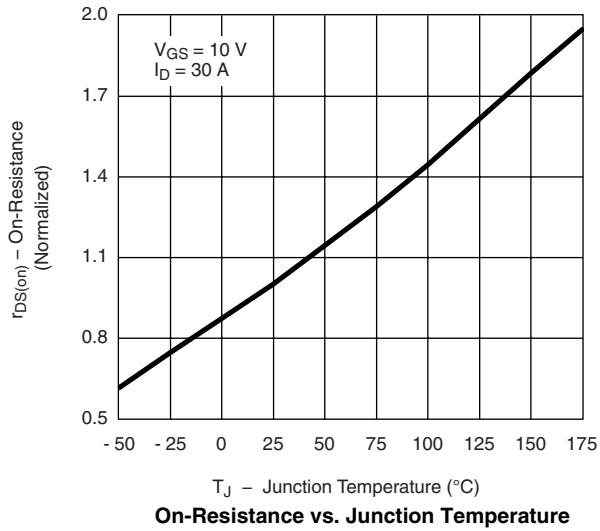


**Capacitance**

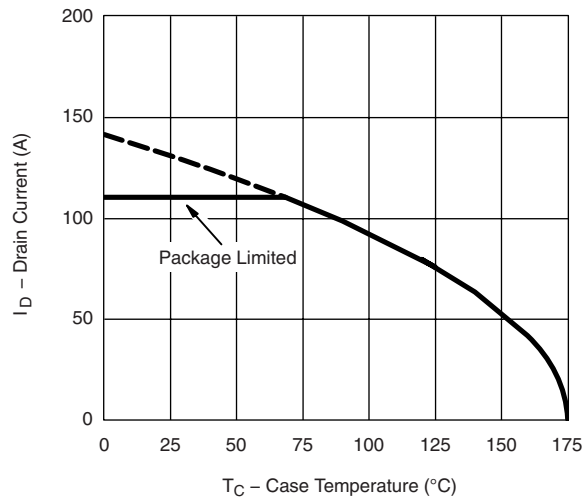


**Gate Charge**

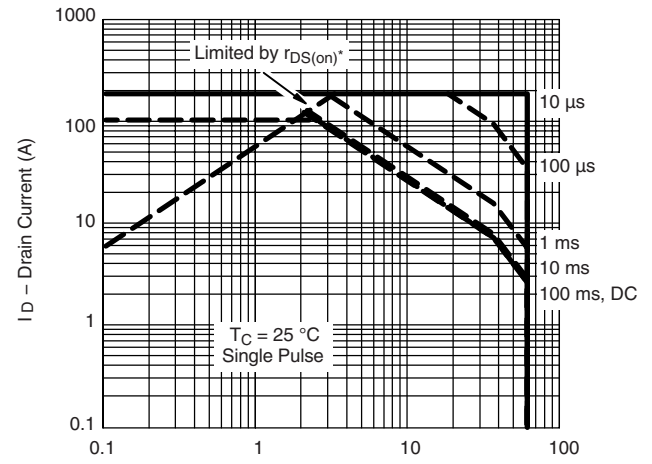
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



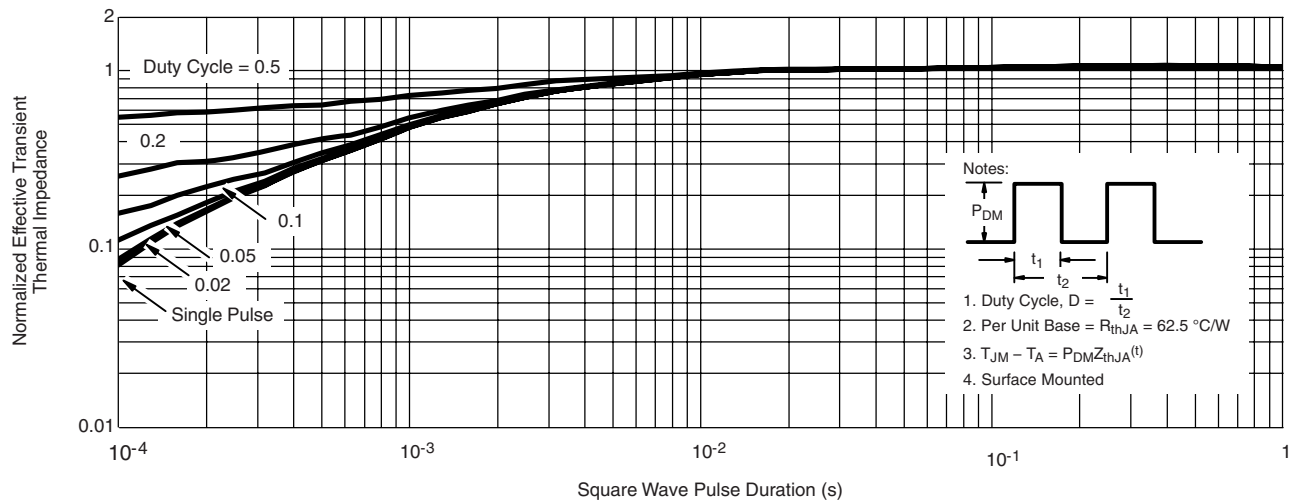
## THERMAL RATINGS



**Maximum Avalanche and Drain Current vs. Case Temperature**

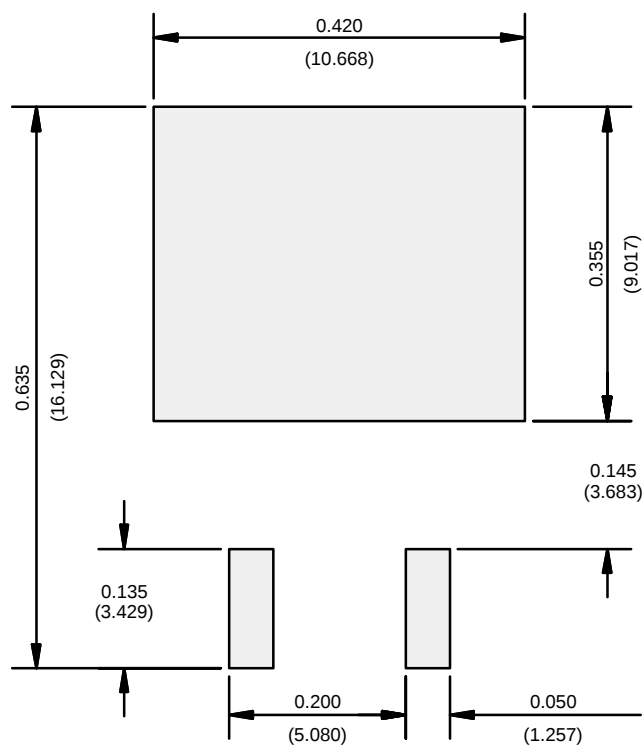


**Safe Operating Area**  
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified



**Normalized Thermal Transient Impedance, Junction-to-Case**

**RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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